# BT139B series H

## **GENERAL DESCRIPTION**

Glass passivated triacs in a plastic for surface envelope suitable mounting, intended for use in applications requiring high noise immunity in addition to high, bidirectional blocking voltage capability and thermal cycling performance. Typical applications include motor control, industrial lighting, heating and static switching.

DESCRIPTION

#### **PINNING - SOT404**

main terminal 1

main terminal 2

main terminal 2

PIN

1

2

3

mb

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V <sub>drm</sub> I <sub>t(rms)</sub> I <sub>tsm</sub>	BT139B- Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current	<b>500H</b> 500 16 140	<b>600H</b> 600 16 140	<b>800H</b> 800 16 140	V A A
	ourient				

#### **PIN CONFIGURATION**

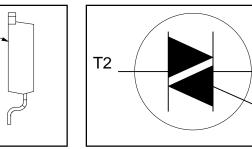
-D-

2

3

1

#### SYMBOL



# T1 G

#### LIMITING VALUES

gate

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
V <sub>drm</sub>	Repetitive peak off-state voltages		-	<b>-500</b> 500 <sup>1</sup>	<b>-600</b> 600 <sup>1</sup>	<b>-800</b> 800	V
I <sub>T(RMS)</sub> I <sub>TSM</sub>	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{mb} \le 99 \degree C$ full sine wave; $T_j = 25 \degree C$ prior to surge	-		16		A
		t = 20  ms	-		140		A
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 16.7 ms t = 10 ms	-		150 98		A A <sup>2</sup> s
dl <sub>⊤</sub> /dt	Repetitive rate of rise of on-state current after	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$			50		
	triggering	T2+G+	-		50		A/μs
		T2+ G- T2- G-	-		50		A/µs
		T2- G- T2- G+	-		50 10		A/μs A/μs
	Peak gate current		-				Å
I <sub>GM</sub> V <sub>GM</sub>	Peak gate voltage		-		2 5 5		V
I P <sub>GM</sub>	Peak gate power		-				W
P <sub>G(AV)</sub> T <sub>stg</sub> T <sub>j</sub>	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	-40 -		0.5 150 125		°℃

<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 Å/µs.

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## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub> R <sub>th j-a</sub>	Thermal resistance junction to mounting base Thermal resistance junction to ambient	full cycle half cycle minimum footprint, FR4 board		- - 55	1.2 1.7 -	K/W K/W K/W

## STATIC CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

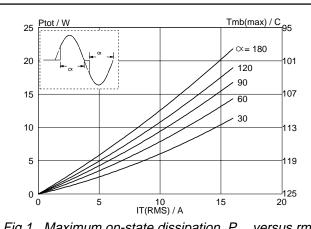
SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
I <sub>GT</sub>	Gate trigger current	$V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$					
01			T2+ G+	10	14	50	mA
			T2+ G-	10	17	50	mA
			T2- G-	10	18	50	mA
			T2- G+	10	40	100	mA
IL .	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$					
			T2+ G+	-	10	60	mA
			T2+ G-	-	25	90	mA
			T2- G-	-	12	60	mA
-			T2- G+	-	14	90	mA
I <sub>H</sub>	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$		-	8	60	mA
I <sub>H</sub> V <sub>T</sub> V <sub>GT</sub>	On-state voltage	$I_{T} = 20 \text{ A}$		-	1.2	1.6	V
V <sub>GT</sub>	Gate trigger voltage	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$		-	0.7	1.5	V
		$V_{\rm D} = 400 \text{ V}; I_{\rm T} = 0.1 \text{ A}; T_{\rm i} = 125 \text{ S}$	°C	0.25	0.4	-	V
I <sub>D</sub>	Off-state leakage current	$V_D = V_{DRM(max)}$ ; $T_j = 125 \ ^{\circ}C$		-	0.1	0.5	mA

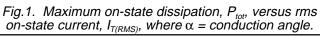
## **DYNAMIC CHARACTERISTICS**

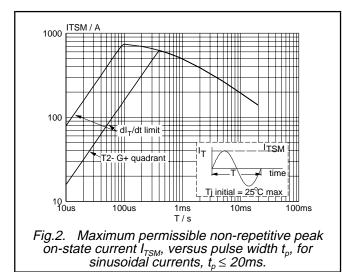
 $T_i = 25$  °C unless otherwise stated

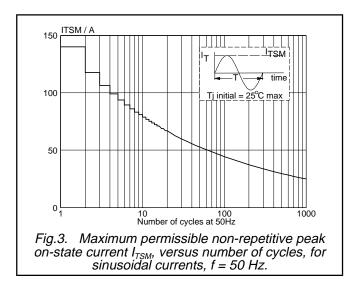
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV <sub>D</sub> /dt	Critical rate of rise of	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$	200	500	-	V/µs
	off-state voltage Critical rate of change of	exponential waveform; gate open circuit $V_{DM} = 400 \text{ V}; \text{ T}_{j} = 95 \text{ °C}; \text{ I}_{T(RMS)} = 16 \text{ A};$	10	20	-	V/µs
t <sub>gt</sub>	commutating voltage Gate controlled turn-on time	$dI_{com}/dt = 7.2 \text{ A}'ms; \text{ gate open circuit}$ $I_{TM} = 20 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu \text{s}$	-	2	-	μs

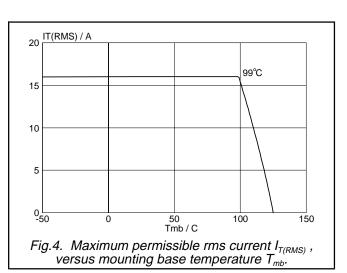
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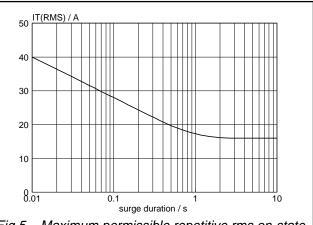
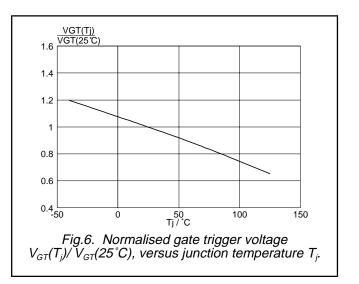
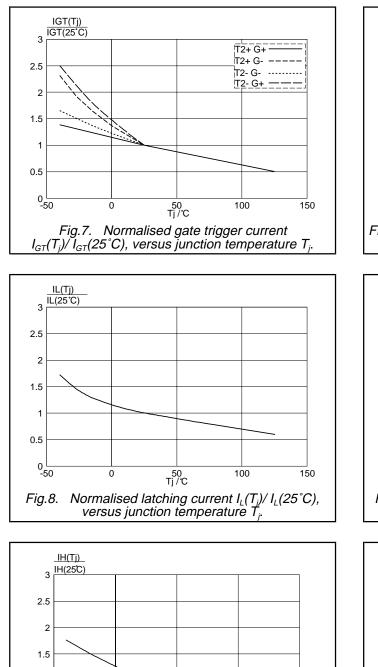
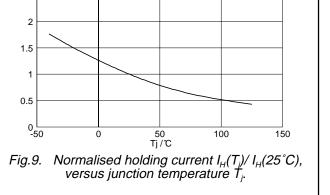


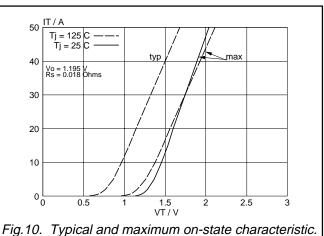
Fig.5. Maximum permissible repetitive rms on-state current  $I_{T(RMS)}$ , versus surge duration, for sinusoidal currents, f = 50 Hz;  $T_{mb} \le 99^{\circ}C$ .

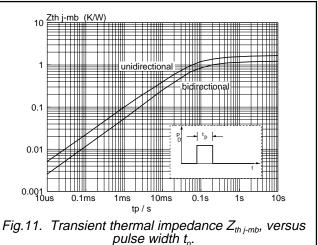


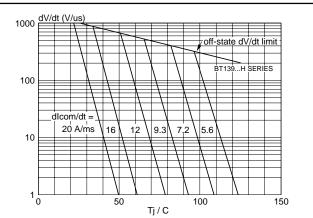
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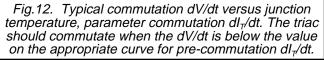








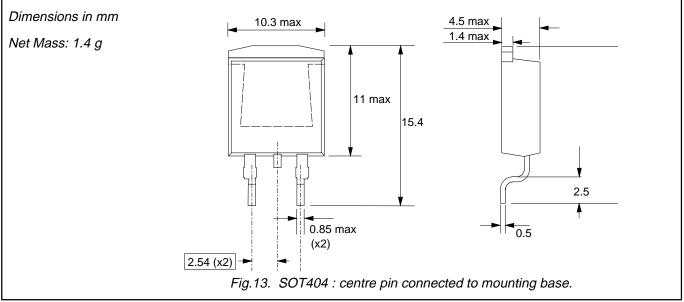




## Product specification

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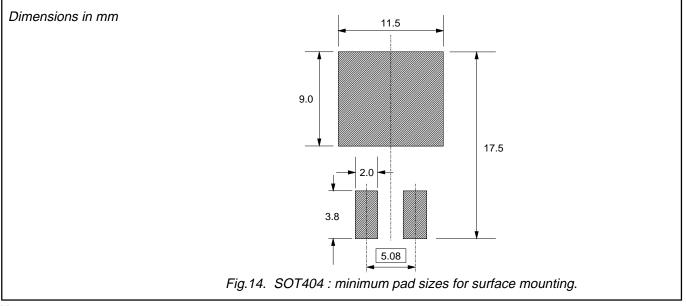
## **MECHANICAL DATA**



#### Notes

1. Epoxy meets UL94 V0 at 1/8".

## **MOUNTING INSTRUCTIONS**



#### Notes

1. Plastic meets UL94 V0 at 1/8".

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## DEFINITIONS

Data sheet status					
Objective specification This data sheet contains target or goal specifications for product development.					
Preliminary specification	reliminary specification This data sheet contains preliminary data; supplementary data may be published later				
Product specification	ecification This data sheet contains final product specifications.				
Limiting values					
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					
Application information					
Where application information is given, it is advisory and does not form part of the specification.					
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